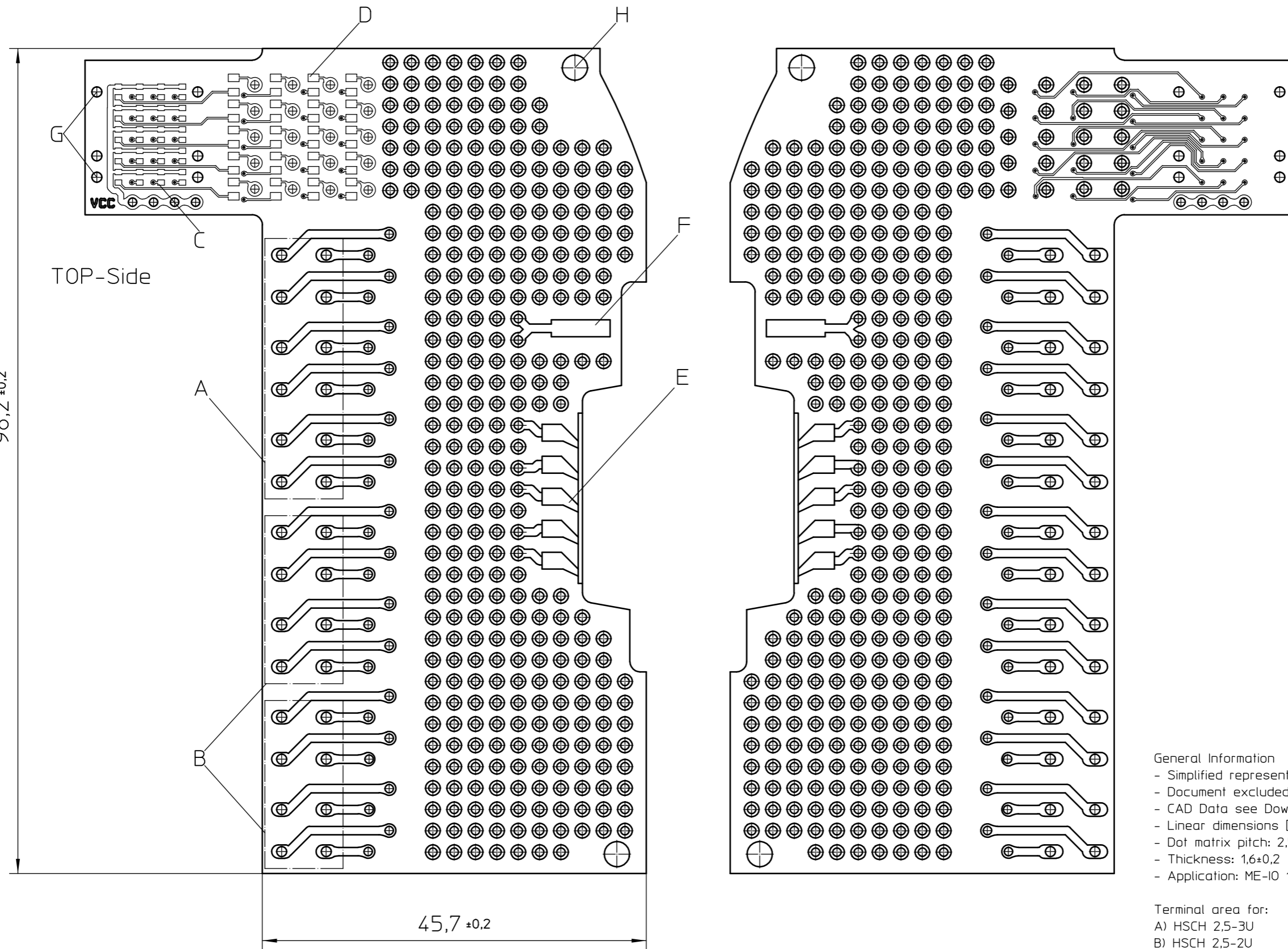


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98,2 ±0,2

TOP-Side



45,7 ±0,2

- General Information
- Simplified representation
 - Document excluded from change process
 - CAD Data see Download-Center on www.phoenixcontact.com
 - Linear dimensions [mm]
 - Dot matrix pitch: 2,54mm ; drill size: $\varnothing 1$
 - Thickness: 1,6±0,2
 - Application: ME-IO 18,8 DEV-KIT

- Terminal area for:
- A) HSCH 2,5-3U
 - B) HSCH 2,5-2U
 - C) Pad for SMD LED 0603
 - D) Pad for SMD Resistor 0603
 - E) Pad for TBUS CONTACT, surface Au
 - F) Pad for FE CONTACT, surface Sn
 - G) Mounting hole for HS LC-H-D2/ R4XC5-2,54
 - H) Hole for latching with ME-IO 18,8 B

DIN A3 	document-No. / RI 00864564 / 00	date 27.04.2015	scale 2:1
	ident.-No. 2202548	document-type PCB outline	
page 1 of 1	description ME-IO 18,8/28 TBUS DEV-PCB		